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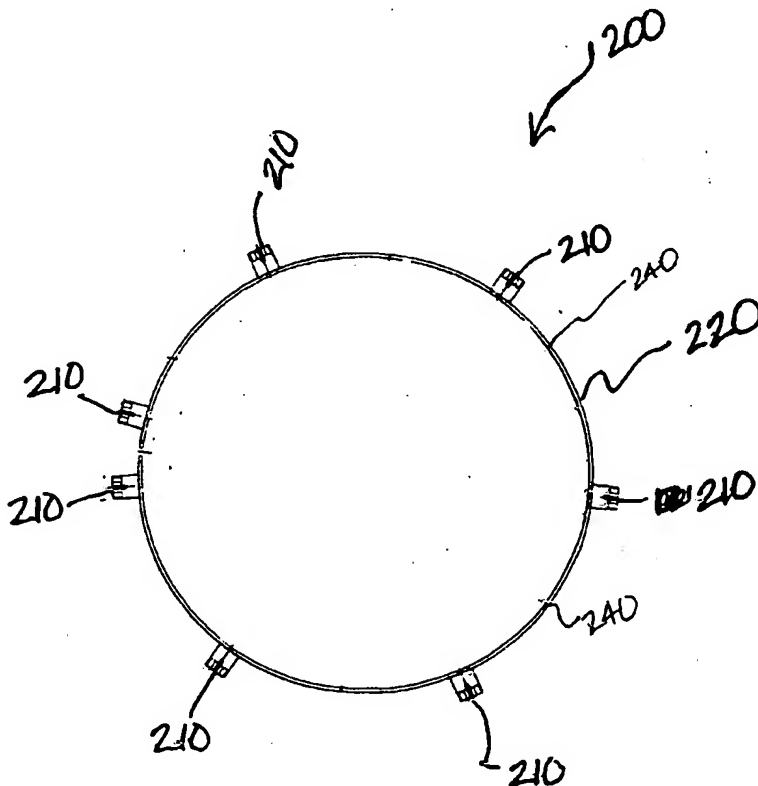
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(54) Title: APPARATUS AND METHODS FOR IONIZED DEPOSITION OF A FILM OR THIN LAYER



(57) **Abstract:** A coil assembly (200) is described herein that comprises a) at least one coil (220) with a width (240); and b) at least one boss (210) coupled to the at least one coil, wherein the at least one boss comprises at least two support sections. Methods of forming and/or producing coil assemblies are described herein and comprise a) providing a coil; b) providing at least one boss having at least two support sections; and c) coupling the at least one boss to the coil.

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